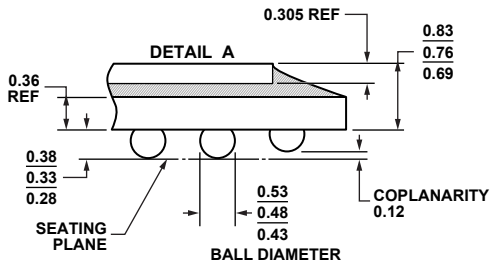
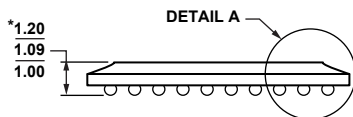
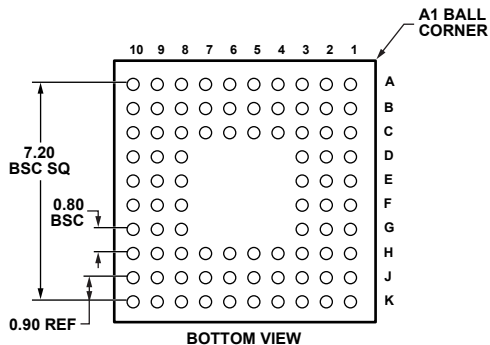
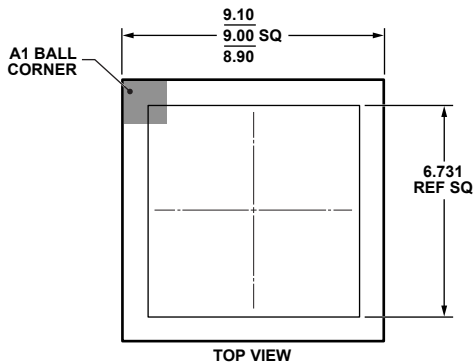


84-Ball Chip Scale Package Ball Grid Array [CSP_BGA]

(BC-84-2)

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-219 WITH
EXCEPTION TO PACKAGE HEIGHT.